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Polarization-Independent Wideband High-Index-Contrast Grating Mirror

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Abstract—Island-type two-dimensional high-index-contrast grating mirror based on a standard silicon-on-insulator wafer have been experimentally demonstrated. The measured spectra shows a bandwidth of ~192 nm with a reflectivity over 99% as well as polarization independence. Numerical simulations show that the designed mirror has large tolerance to fabrication errors.

Index Terms—High index contrast, VCSEL, polarization, sub-wavelength grating.

I. INTRODUCTION

The grating structure referred to as high-index-contrast grating (HCG) is a single layer of near subwavelength grating with large refractive index difference from surrounding materials [1]. Since HCGs can exhibit high reflectivity over a broad wavelength range [2], [3], they have attracted much attention as an alternative to distributed Bragg reflectors (DBRs) especially for vertical-cavity surface-emitting laser (VCSEL) applications. By replacing one or both of the DBRs in a VCSEL with the HCG reflector, various interesting VCSEL structures with novel properties have been demonstrated [4]–[16]. The use of HCG reflector structure formed in the silicon (Si) layer of a silicon-on-insulator (SOI) wafer together with a direct wafer bonding with a III-V semiconductor with a gain material can innovate the fabrication processes of long wavelength VCSELs [8]–[11], [14]–[16], removing the need for growth of thick InP-lattice-matched DBRs or double wafer fusion of GaAs-lattice-matched DBRs [17]. Furthermore, it may bring novel characteristics including a high modulation speed over 100 Gb/s [16] and a capability of emitting output light laterally into a Si waveguide [8], [11], [16] which is highly desirable for chip-level optical interconnects.

So far, most of studies on HCGs mentioned above have been focused on one-dimensional (1D) HCGs. These 1D HCG reflectors are polarization-dependent due to the asymmetry of the grating profile for transverse electric (TE) and transverse magnetic (TM) polarizations and hence can provide a high reflectivity to a specific polarization at a given wavelength. This polarization selectivity is an advantage for VCSELs for communication applications that have been of most interest so far. However, recently, there is increasing need for polarization-independent HCGs, which requires two-dimensional (2D) HCG. For example, Tsunami et al. have proposed to use 2D HCG reflectors on a SOI wafer to realize a 2D network of VCSEL-based optical buffer memories [14]. In this proposed structure, the polarization independence of the 2D HCG reflectors is essential to achieve polarization-bistable oscillations and switching in the 2D-HCG based VCSELs [18]. In VCSEL-based Doppler velocimetry applications [19], 2D HCGs has a potential to innovate the device structure.

Recently, several types of 2D HCGs have been studied, aiming at polarization-independent wideband reflectors with reflectivity $R \geq 99\%$. They include a crossed type [14], [20], an island type [21], and a two-layered cross-stacked type [22]. For the two-layered type reflector consisting of two layers of 1D HCGs, a broad bandwidth of 200 nm has been demonstrated. However, its complex fabrication steps could be a drawback and it appears mechanically unstable for a direct wafer bonding. For the crossed type 2D HCG where two 1D HCGs are connected to each other in a single layer, a broad bandwidth of 200 nm and an integration with a VCSEL has been demonstrated. However, complex fabrication steps could be a drawback and it appears mechanically unstable for a direct wafer bonding. For the crossed type 2D HCG where two 1D HCGs are connected to each other in a single layer, a broad bandwidth of 200 nm and an integration with a VCSEL has been demonstrated. However, complex fabrication steps could be a drawback and it appears mechanically unstable for a direct wafer bonding. For the crossed type 2D HCG where two 1D HCGs are connected to each other in a single layer, a broad bandwidth of 200 nm and an integration with a VCSEL has been demonstrated.

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II. DESIGN AND FABRICATION TOLERANCE STUDY

Fig. 1 shows a schematic diagram of an island type 2D HCG with design parameters such as grating refractive index ($n_H$), refractive index of the layer underneath the grating ($n_L$), refractive index of the substrate ($n_S$), grating layer thickness ($T_g$), thickness of the layer below the grating ($T_L$), grating period in $x$ or $y$ direction ($\Lambda_{x,y}$), and grating width in $x$ or $y$ directions ($w_{x,y}$). Some of the design parameters are determined from the standard SOI wafer used for fabrication. These include: $n_H=3.47$, $n_L=1.47$, $n_S=3.47$, $T_g=500$ nm, and $T_L=3\mu$m. Furthermore, to guarantee polarization-independence, the grating should be symmetric after $90^\circ$ rotation. This requirement demands that $\Lambda_x = \Lambda_y$ and $w_x = w_y$. Additionally, it is assumed that the region above the grating is air, all the refractive indices are isotropic and non-dispersive, and the incidence angle ($\theta_{inc}$) is zero.

Firstly, with these pre-conditions, 2D numerical simulations based on rigorous coupled-wave analysis (RCWA) [23] are performed to find optimum parameter sets, i.e., ($w_x, \Lambda_x$). In order to ensure the accuracy of calculation, 60 diffraction orders were considered. Fig. 2 shows the calculated reflectance and transmittance spectra for an optimum parameter set. As typically observed in 1D HCGs, there are two dips in the transmission spectrum within the stop band, which correspond to two guided mode resonances (GMRs). The bandwidth with reflectivity higher than 99% is $\sim 192$ nm for the wavelength range of 1458 nm to 1650 nm.

Then, the tolerance of reflection properties over fabrication errors are estimated for the optimal set. Geometrical parameters, i.e., the grating period, grating thickness, and grating width are separately varied around the optimal grating period of 700 nm, the Si layer thickness of a standard SOI wafer of 500 nm, and the optimal grating width of 410 nm respectively. While one parameter is varied, the others are kept constant. The results are shown in Fig. 3. Allowed parameter variations while still achieving reflectivity, $R \geq 99\%$ and bandwidth, $\Delta\lambda \sim 192$ nm, are evaluated by changing the parameter values centered around the optimum parameter values. It is found that both grating thickness and width have $\pm 20$ nm tolerance while the grating period has $\pm 30$ nm. These tolerances are achievable within the accuracy limit of e-beam lithography and dry etching processes. We need to note that the tolerance analysis presented in Fig. 3 has simplified the real situation by assuming all other parameters except for one are constant. However, in reality all the grating parameters can vary simultaneously, uncorrelated to each other during the fabrication processes. To further investigate these effects a more rigorous analysis based on Monte Carlo simulation [24] is implemented.

Monte Carlo simulation is performed to explore sensitivity of design parameters for 1000 sample parameter sets each with random $\Lambda_x$, $\Lambda_y$, $w_x$ and $w_y$ values having Gaussian distribution, as shown in the histogram plots in Figs. 4(a) to 4(d). All the distributions are centered around the optimum parameter values with a standard deviation ($\sigma$) of 5 nm, which is a probable value occurring in fabrication processes. The simulation results presented in Figs. 4(e) and 4(f) show that most of samples have a reflectivity higher than 99.5 % at 1.55 $\mu$m and a bandwidth wider than 180 nm. This indicates
Fig. 4. Fabrication sensitivity analysis with Monte Carlo method. Histogram plot of (a) Grating width in x direction (b) Grating width in y direction (c) Grating period in x direction (d) Grating period in y direction. Monte Carlo analysis results for (e) reflectivity and (f) bandwidth of 2D HCG.

Fig. 5. Scanning electron microscope (SEM) image of the fabricated 2D HCG mirror. Grating is formed in the Si layer of a SOI wafer.

that the island-type 2D HCG design found in this study is robust to uncorrelated variation of parameters introduced during fabrication processes.

III. RESULTS AND DISCUSSION

Samples were prepared by electron beam lithography (JEOL JBX-9500FS) and dry etching processes. The dry etching of silicon involves etching and passivation phases in a cyclic process called Bosch process. A scanning electron microscope image of the fabricated sample tilted at an angle is shown in Fig. 5. The side walls of square islands show vertical profile indicating successful etching of the crystalline silicon. Additionally, the samples show smooth surfaces with etching roughness less than few nanometers.

The characterization of the device was done by illuminating super-continuum light with a beam diameter of approximately 300 µm with a spectral range of 1300 nm to 1750 nm, onto the grating area of 500 µm × 500 µm at an incident angle of θ_{inc}≈3°. This angle of incidence is introduced to separate the optical paths of the incoming and reflected waves. The reflected light from the grating was collected by a parabolic mirror and coupled to a multimode fiber which fed the light to an optical spectrum analyzer (Ando AQ6317B). The spectrum was then normalized with respect to the reflectance spectrum of a reference aluminum mirror.

In Fig. 6(a), the measured and calculated reflectance spectra for TM polarization are plotted at θ_{inc}≈3° in dB scale, showing a good agreement. Calculated reflectance spectra for all linear polarization angles are the same as the simulated spectrum shown at TM polarization. It is noteworthy that there is a sharp resonance peak around 1355 nm, which is not found in the spectrum of Fig. 2 calculated for θ_{inc}=0°. When the incident plane wave impinges at an oblique incidence, odd symmetry modes that cannot be excited at normal incidence due to symmetry, can be excited [25]. This sharp resonance peak corresponds to the excitation of odd modes with a relatively high Q factor. Small difference in peak wavelengths between the measured and calculated spectrum can be attributed to the neglected dispersion in calculations.

In Fig. 6(b) shows the measured reflectance spectra at three linear polarization angles (θ_{pol}). The TM and TE polarizations
correspond to $\theta_{pol}=0^\circ$ and $90^\circ$, respectively. The overall reflection spectrum and resonance peak are maintained for all linear polarization angles. Note that the measurement at $\theta_{pol}=90^\circ$ is in turn compared with the calculated reflectance spectrum in Fig. 6(a). Therefore, we may conclude that the fabricated sample shows polarization-independent reflectivity.

IV. CONCLUSION

We have numerically designed and experimentally demonstrated an island-type 2D HCG on a standard SOI wafer. The fabricated sample exhibits a broadband polarization-independent reflection spectra. Numerical investigations show that this island-type 2D grating structure has good tolerance over fabrication errors. This island-type 2D HCG reflector appears promising for long wavelength VCSELs integrated onto a SOI wafer.

REFERENCES


